Tyrone Camarero Specifications

Camarero DS4007E1-316RT

Key features

- Corporate Database, Database Processing & Storage, Enterprise Server, HPC, Data Center, iSCSI SAN
- 2nd Generation Intel® Xeon® Scalable Processors (Cascade Lake-SP), Intel® Xeon® Scalable Processors.Dual Socket P (LGA 3647) supported, CPU TDP support 205W, 3 UPI up to 10.4 GT/s
- Intel® C622
- Up to 4TB 3DS ECC RDIMM, DDR4-2933MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-2933MHz, in 16 DIMM slots;Up to 2TB Intel® Optane™ DC Persistent Memory in memory mode (Cascade Lake only);
- 3 PCI-E 3.0 x16, 4 PCI-E 3.0 x8 (slot 2 & 3 occupied by controller and JBOD expansion port)
- 16 Hot-swap 3.5" SAS3/SATA3 direct attached drive bays
- Broadcom 3108 SAS3 AOC
- 2x 10GBase-T LAN ports with Intel X722 + PHY Intel X557
- Server remote management: IPMI 2.0 / KVM over LAN / Media over LAN
- 3 Hot-swap 8cm redundant PWM cooling fans, 2 hot-swap 8cm rear exhaust PWM fans
- 1200W Redundant Power Supplies Titanium Level (96%)









Processor/Cache

Processor 2nd Generation Intel® Xeon® Scalable

Processors (Cascade Lake-SP), Intel® Xeon® Scalable Processors.Dual Socket P (LGA 3647) supported, CPU TDP support

205W, 3 UPI up to 10.4 GT/s

Chipset

Chipset Intel® C622

System Memory

Memory Capacity Up to 4TB 3DS ECC RDIMM, DDR4-

2933MHz; Up to 4TB 3DS ECC LRDIMM, DDR4-2933MHz, in 16 DIMM slots;Up to 2TB Intel® Optane™ DC Persistent Memory in memory mode

(Cascade Lake only);

Expansion Slots

PCI-Express 3 PCI-E 3.0 x16, 4 PCI-E 3.0 x8

(slot 2 & 3 occupied by controller and JBOD expansion port)

Integrated On-Board

SAS SAS3 (12Gbps) via Broadcom 3108 AOC;

HW RAID. RAID 0, 1, 5, 6, 10, 50, 60

SATA SATA3 (6Gbps) with RAID 0, 1, 5, 10

LAN 2 RJ45 10GBase-T LAN ports,

1 RJ45 Dedicated IPMI LAN port

Add-on Options

Optical Drive None

Front Panel

LED Indicators Power status LED, Hard drive activity LED,

Network activity LEDs, System Overheat LED,

Power fail LED

Buttons Power On/Off button, System Reset button

Drive Bays

HDD bays 16 Hot-swap 3.5" SAS3/SATA3 drive bays,

2 Optional Onboard NVMe M.2

Power Supply

1200W Redundant Power Supplies Titanium Level (96%)

Cooling System

3 Hot-swap 8cm redundant PWM cooling fans,

2 hot-swap 8cm rear exhaust PWM fans

Form Factor

Form Factor 3U Rackmount

Width: 17.2" (437mm), Height: 5.2" (132mm), Depth: 25.5" (648mm)

Email: info@tyronesystems.com

For more/current product information, visit www.tyronesystems.com

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